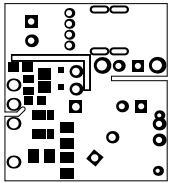
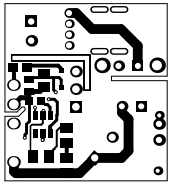


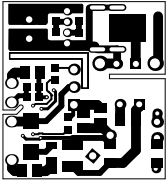
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/25/2013 4:16:30 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 10/25/2013 4:16:30 PM	TEXAS INSTRUMENTS	

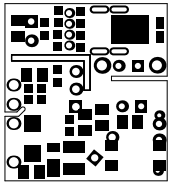


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 10/25/2013 4:16:31 PM	TEXAS INSTRUMENTS	

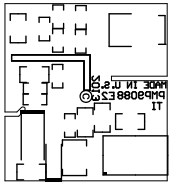


SUN: 523 [Locally Modified]

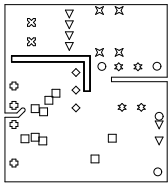
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 10/25/2013 4:16:32 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/25/2013 4:16:33 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME =Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/25/2013 4:16:33 PM	TEXAS INSTRUMENTS	

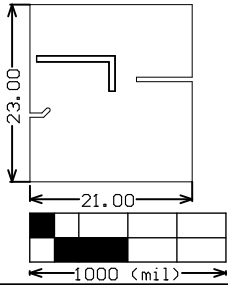


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	HOL
□	7	10mil (0.254mm)			PTH	Rou
○	2	21mil (0.533mm)			PTH	Rou
✱	4	31mil (0.787mm)			PTH	Rou
▽	4	31.496mil (0.8mm)			PTH	Rou
▽	2	32mil (0.813mm)			PTH	Rou
⊗	2	33mil (0.838mm)			PTH	Rou
□	2	37.402mil (0.95mm)			PTH	Rou
◇	3	39.37mil (1mm)			PTH	Rou
⊕	4	50mil (1.27mm)			PTH	Rou
○	2	51.181mil (1.3mm)			PTH	Rou
⊗	4	21mil (0.533mm)	78.74mil (2mm)	57.74mil (1.467mm)	PTH	Slo
	36 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end
 Physical Length = Rout Path Length + Tool Size = Slot length as defined

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 10/25/2013 4:16:34 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9088	REV: E2	SUN REV: 523 [Locally Modified]
LAYER NAME =M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 10/25/2013 4:16:35 PM	TEXAS INSTRUMENTS	

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